

## 1200V 40mΩ N-Channel SiC Power MOSFET

### Description

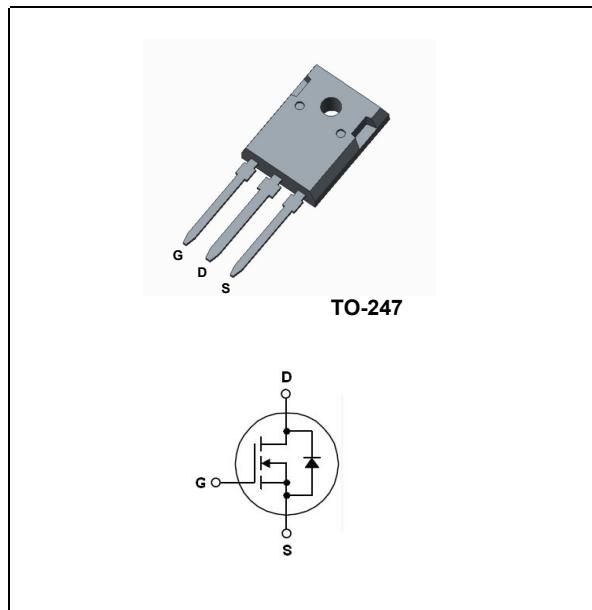
The AKCT40N120H is a high blocking voltage N-Channel SiC power MOSFET. This device provide excellent performance for high voltage power supplies or pulse circuits.

### Features

- Typical on-Resistance:  $R_{DS(on)}=40m\Omega$ (typ.)
- High Blocking Voltage
- 100% Avalanche Test
- Good Stability and Uniformity with High  $E_{AS}$

### Applications

- Solar Inverters
- High Voltage DC/DC Converters
- Motor Drivers
- Switch Mode Power Supplies



### Absolute Maximum Ratings @ $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain to Source Voltage	1200	V
$V_{GSS}$	Gate to Source Voltage	-10/+25	V
$V_{GSop}$	Recommended operation Values of Gate -Source Voltage	-5/+20	V
$I_D$	Drain Current	$T_c=25^\circ C$	61
		$T_c=100^\circ C$	42
$I_{DM}$	Pulsed Drain Current (Note1)	120	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ C$	250
	Derate above 25°C		1.67
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	300	mJ
$T_J$	Operating Junction Temperature Range	-50~+175	°C
$T_{STG}$	Storage Temperature Range	-50~+175	°C

### Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	0.6	°C/W
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	°C/W

**Electrical Characteristics @ $T_C=25^\circ\text{C}$  unless otherwise noted**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain to Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=2\text{mA}$	1200	-	-	V
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=5\text{mA}$	2.0	2.5	4.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=20\text{V}, I_{\text{D}}=20\text{A}$	-	44	65	$\text{m}\Omega$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=V_{\text{DSS}}, V_{\text{GS}}=0\text{V}$	-	-	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Source Leakage Current	$V_{\text{GS}}=V_{\text{GSS}}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 500$	nA

**D-S Diode Characteristics and Maximum Rating @ $T_C=25^\circ\text{C}$  unless otherwise noted**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=40\text{A}$	-	3.9	-	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=40\text{A},$ $\text{di/dt}=-290\text{A/us}$	-	30	-	ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=40\text{A},$ $\text{di/dt}=-290\text{A/us}$	-	590	-	nC

**Switching Characteristics @ $T_C=25^\circ\text{C}$  unless otherwise noted**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{\text{d(on)}}$	Turn-on Delay Time	$I_{\text{D}}=40\text{A},$ $V_{\text{DD}}=800\text{V},$ $R_{\text{G}}=2.5\Omega$ $V_{\text{GS}} = -5/20\text{V},$ (Note 3)	-	12	-	ns
$t_r$	Turn-on Rise Time		-	12	-	ns
$t_{\text{d(off)}}$	Turn-off Delay Time		-	23	-	ns
$t_f$	Turn-off Fall Time		-	6.7	-	ns
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=1000\text{V},$ $f=1.0\text{MHz}$	-	2946	-	pF
$C_{\text{oss}}$	Output Capacitance		-	167	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	6.6	-	pF
$Q_g$	Total Gate Charge	$I_{\text{D}}=40\text{A},$ $V_{\text{DD}}=800\text{V}$ $V_{\text{GS}}=-5/20\text{V}$ (Note 3)	-	142	-	nC
$Q_{\text{ge}}$	Gate to Source Charge		-	37	-	nC
$Q_{\text{gd}}$	Gate to Drain Charge		-	18	-	nC

**Note:**

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $V_{\text{DD}}=100\text{V}$ ,  $L=10\text{mH}$ ,  $V_{\text{clamp}}=1600\text{V}$ ,  $V_{\text{G}}=10\text{V}$ ,  $I_{\text{D}}=19.0\text{A}$
3. Essentially independent of operating temperature typical characteristics

## Typical Performance Characteristics

Fig. 1. Typical on-Resistance Characteristics

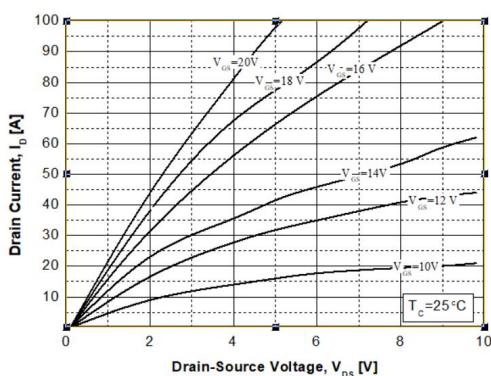


Fig. 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

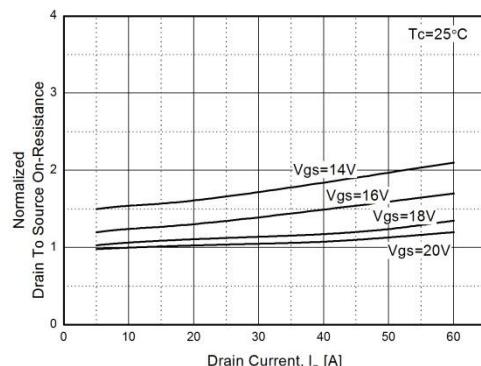


Fig. 3. Normalized On-Resistance vs. Junction Temperature

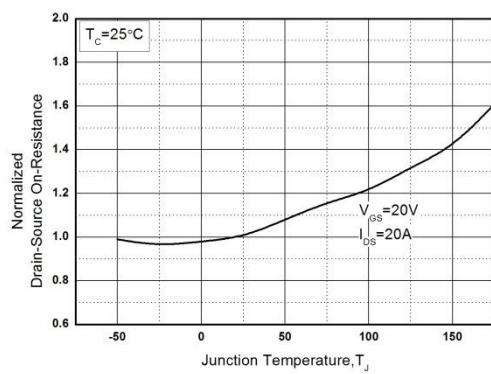


Fig. 4. On-Resistance vs. Gate-to-source Voltage

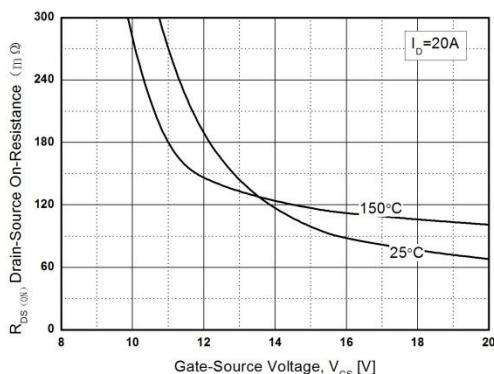


Fig. 5. Transfer Characteristics

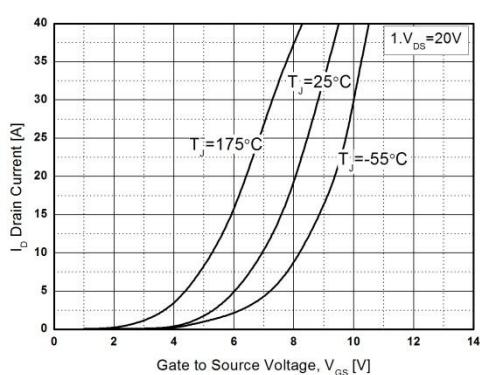
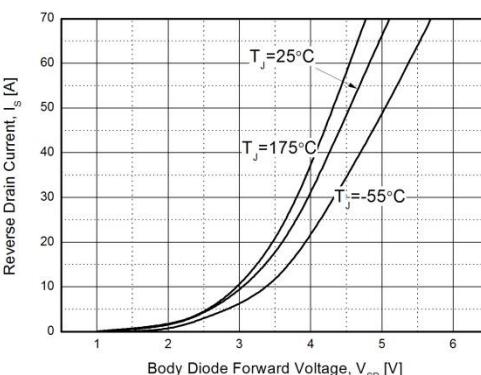


Fig. 6. Source-to-Drain Diode Forward Voltage vs. Source Current



## Typical Performance Characteristics

Fig. 7. Gate Charge Characteristics

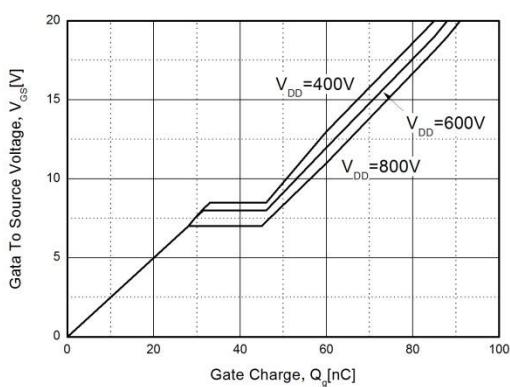


Fig. 8. Characteristics vs. Drain-to-Source Voltage

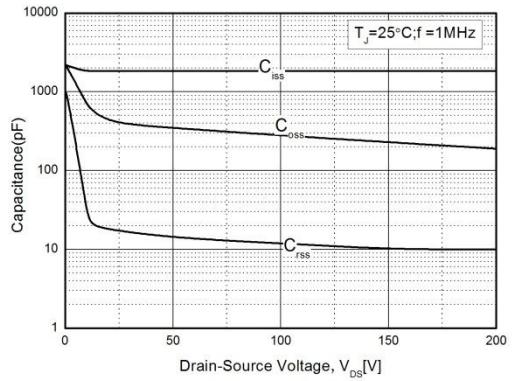
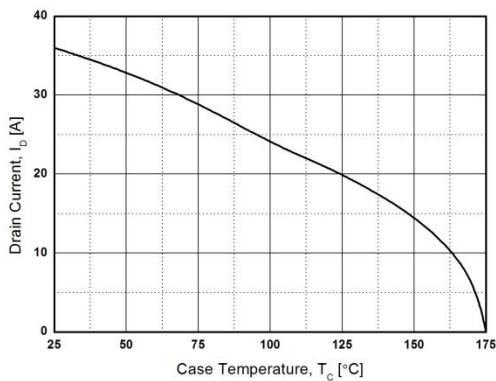


Fig. 9. Maximum Drain Current vs. Temperature



**Package Dimensions****TO-247**

(Dimensions in Millimeters)

